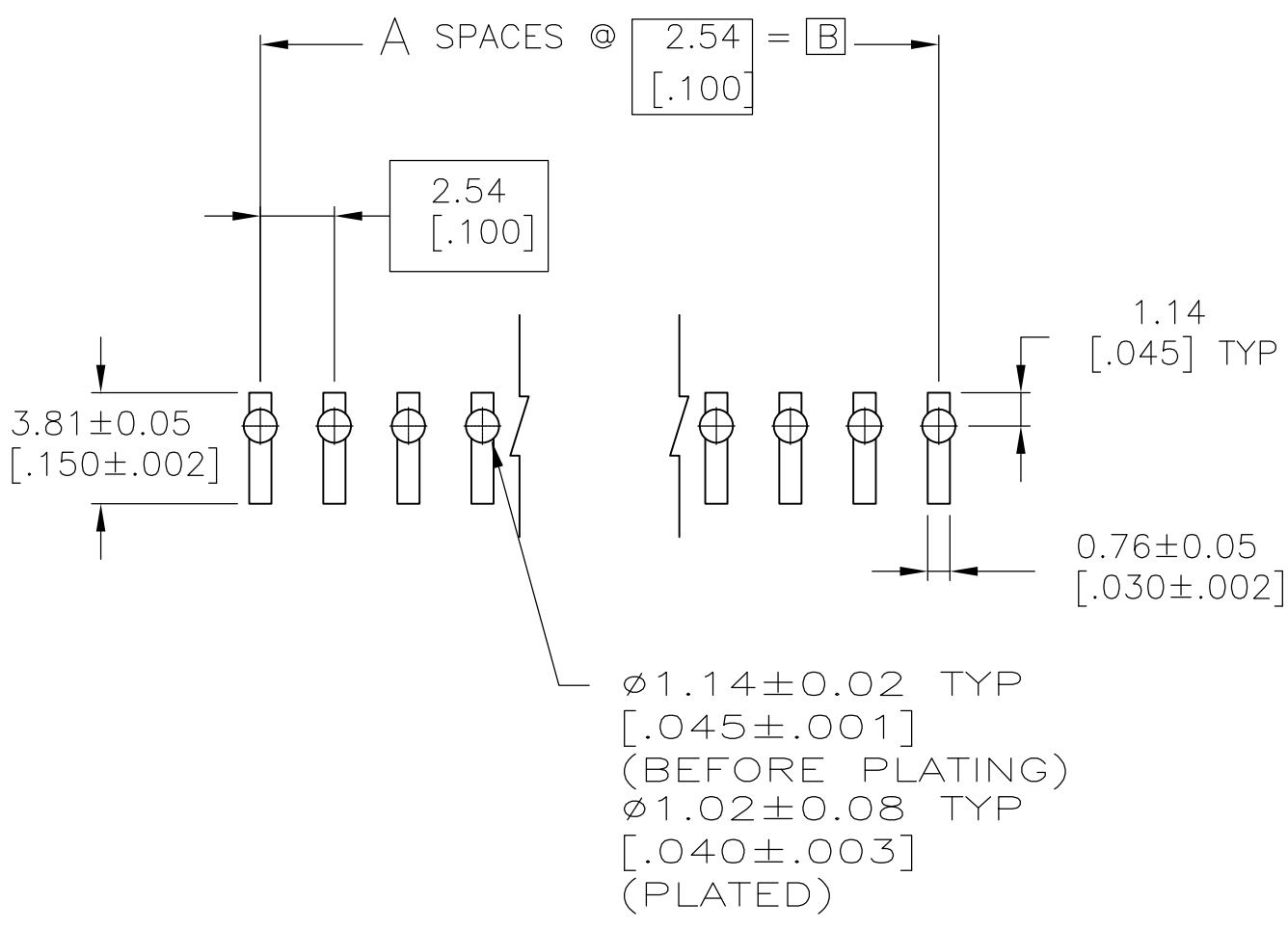
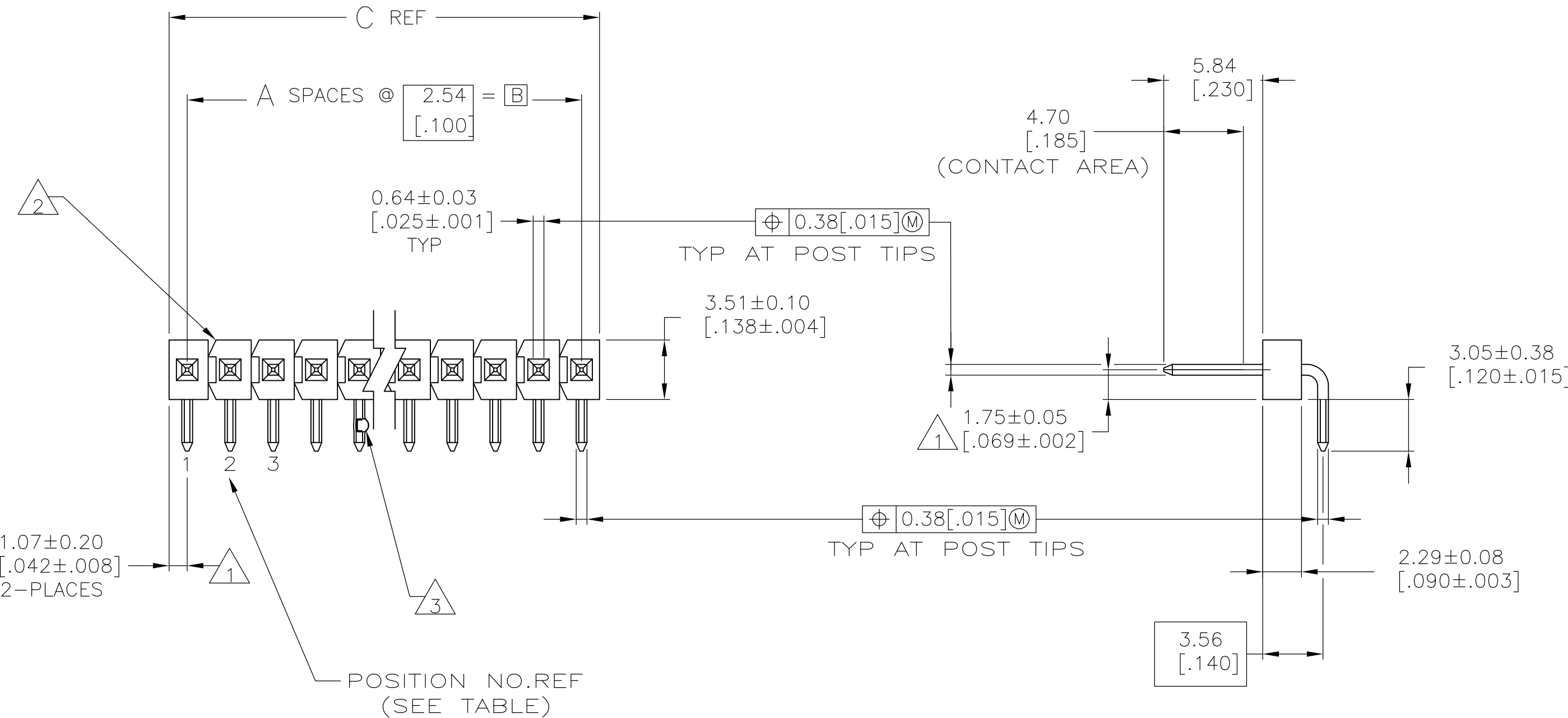


RECOMMENDED PC BOARD MOUNTING DIMENSIONS
FOR .063 [1.60] THICK PC BOARD AND
.012 [.305] STENCIL THICK.

DETAIL Z
POST DETAIL TYP.
2 POST MINIMUM
SCALE 20:1

- 1 THE NOTED DIMENSIONS APPLY AT THE INTERSECTION OF THE POST AND HOUSING.
- 2 BREAKAWAY NOTCH ANGLE CAN BE ORIENTED TO THE RIGHT (AS SHOWN) OR TO THE LEFT
- 3 SELECTIVE POSTS ARE FORMED TO PROVIDE CONNECTOR RETENTION TO PC BOARD UNTIL SOLDERED. RETENTION FEATURE IS FOR .055 MINIMUM PC BOARD THICKNESS. (SEE DETAIL Z FOR FORM AND TABLE FOR LOCATIONS.)
- 4 0.000762 [.000030] GOLD ON CONTACT AREA, 0.00254-0.00508 [.000100-.000200] MATTE TIN-LEAD, ON SOLDER TAIL, ALL OVER 0.00127 [.000050] NICKEL.
- 5 HOUSING: GLASS FILLED THERMOPLASTIC, COLOR, BLACK. (WILL WITHSTAND VAPOR PHASE REFLOW.) CONTACT: COPPER ALLOY.
- 6 0.000762 [.000030] GOLD ON CONTACT AREA, 0.00254-0.00508 [.000100-.000200] MATTE TIN ON SOLDER TAIL, ALL OVER 0.00127 [.000050] NICKEL.
- 7 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

THIS DRAWING IS A CONTROLLED DOCUMENT.

DWN
T. HOFFMAN 21JUN95
CHK
G. DUBNICZKI 04DEC95
APVD
G. DUBNICZKI 04DEC95

TE Connectivity

DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	NAME
0 PLC ± - 1 PLC ± - 2 PLC ± 0.51[.02] 3 PLC ± 0.127[.005] 4 PLC ± 0.0127[.0005] ANGLES ± -	PRODUCT SPEC APPLICATION SPEC	HEADER ASSEMBLY, MOD II, BREAKAWAY, HIGH TEMP, RIGHT ANGLE, SINGLE ROW, .100 C/L, W/.025 SQUARE POSTS WITH HOLD-DOWN CONFIG.
MATERIAL 5	FINISH SEE TABLE	SIZE A1
CUSTOMER DRAWING		SCALE 4:1 SHEET 1 OF 2 REV D

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8	7	6	5	4	3	2	1
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